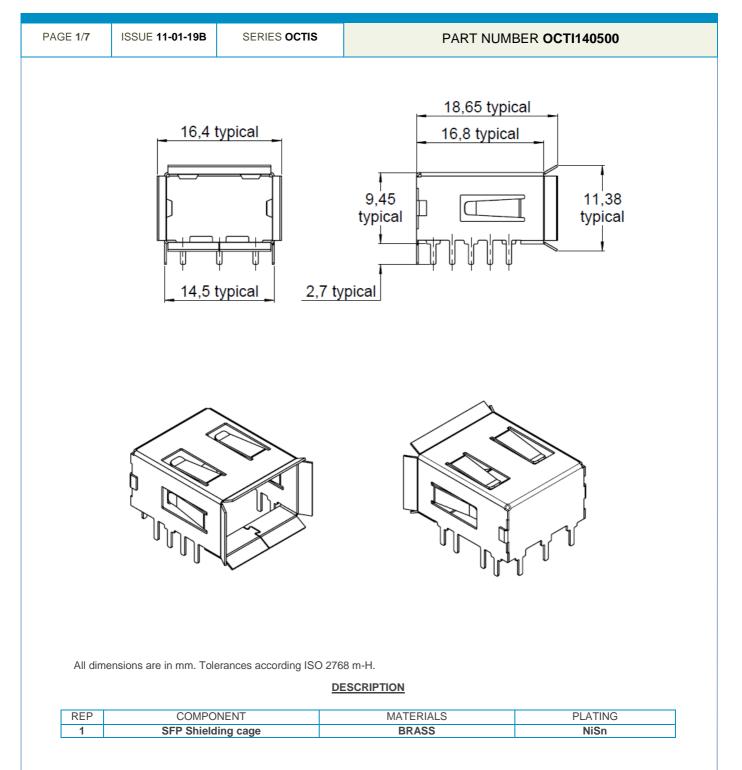


OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY



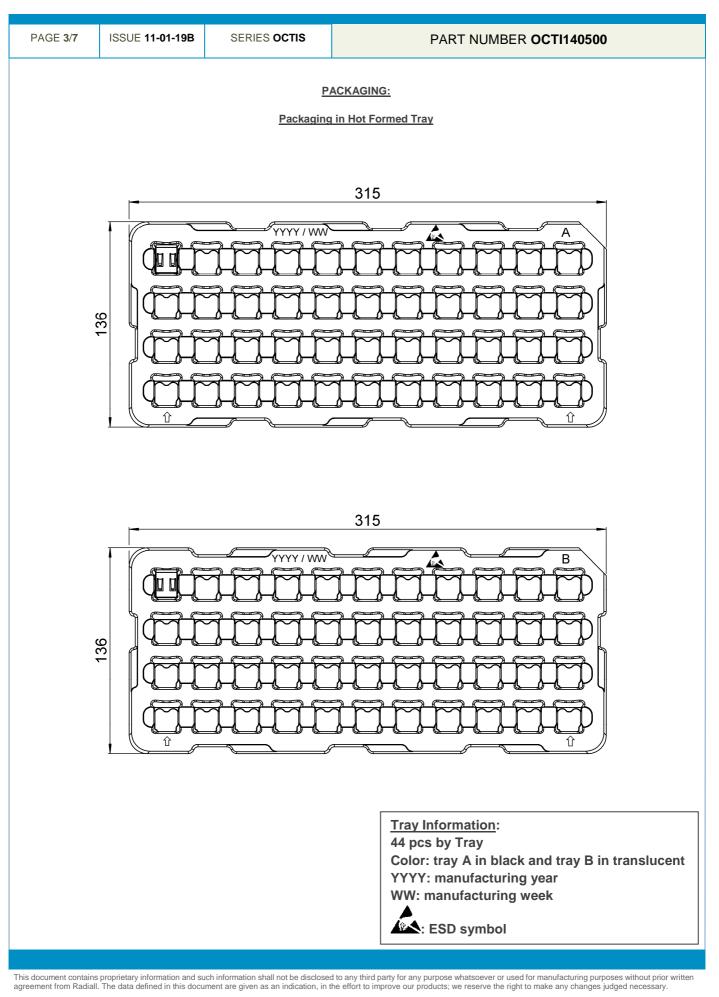


OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY

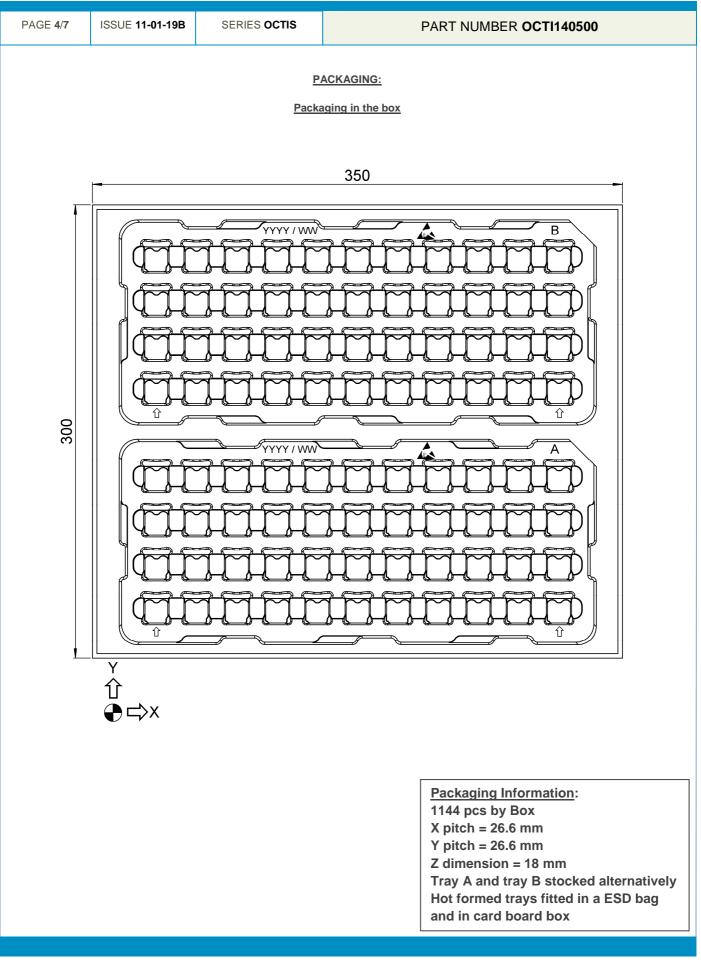
PAGE 2/7	ISSUE 11-01-19B	SERIES OCTIS	PART NUMBER OCTI140500			
GENERAL CHARACTERISTICS						
Mechanical Mating endurance (cycles) Vibration Weight (g)		IEC 61300-2-2 IEC 61300-2-1 -	100 - 1,6530			
Environmental Operating temperature (°C) Storage temperature (°C) RoHS		IEC 61300-2-22 IEC 61300-2-22 -	-40 / +85 -65 / +85 Compliant			
Others - Handling		-	ESD approved Only with gloves			



OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY



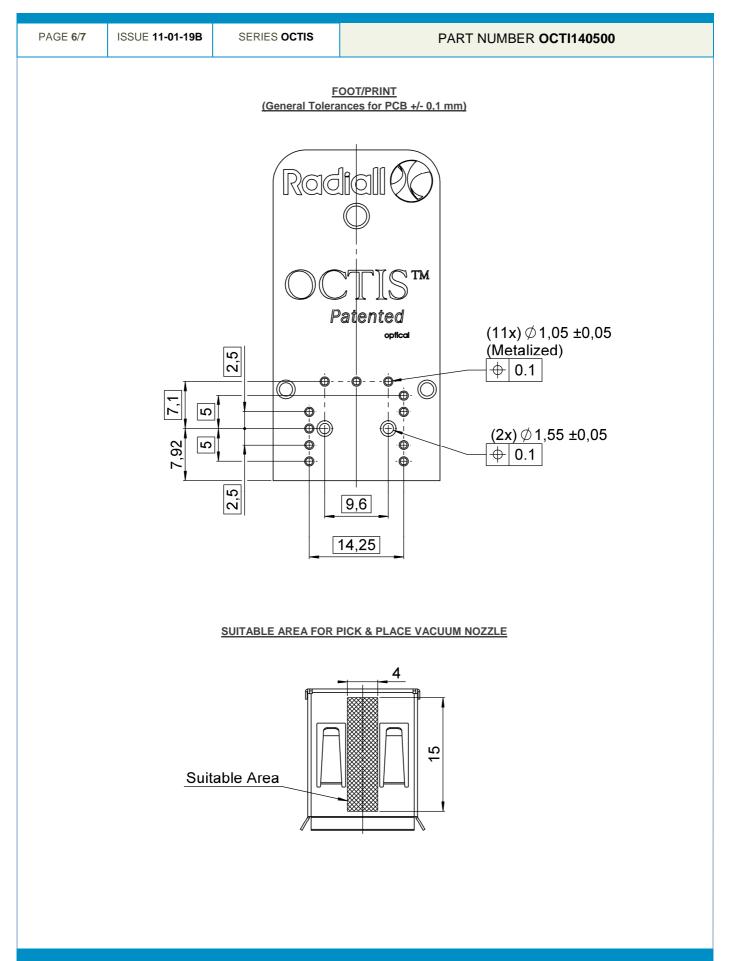
OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY



Technical Data Sheet OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY PAGE 5/7 ISSUE 11-01-19B SERIES OCTIS PART NUMBER OCTI140500 **POSITIONNING AND PATTERN DEFINITION** OCTIS SFP Version with universal receptacle $5,72 \pm 0,40$ (3,5) 32,58 ±0,30 **MECT** locating holes \emptyset 1,55 ±0,05 32,58 ±0,30 0 tented Reference \bigcirc point MECT connector for illustration > ±0,6 Centering of the shielding cage vs receptacle cavity For use with OCTIS Plug Kit p/n OCTI.117.500



OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY





OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY

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ISSUE 11-01-19B

SERIES OCTIS

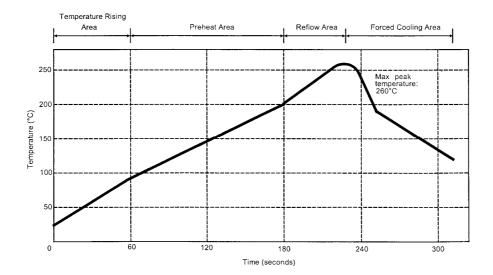
PART NUMBER OCTI140500

SOLDER PROCEDURE*

- 1. Deposit solder paste (Sn Ag4 Cu0.5) on solder pads / mounting area by screen printing application. We recommend a low residue flux. Verify that the edges of the pads are clean.
- 2. Place the component on the mounting area with a pick & place machine. A video camera is recommended for a good positioning of the component. Adhesive agents must not be used on the component.
- 3. This process of soldering has been tested with a convection oven. Below please find the typical soldering profile to use.
- 4. Optional cleaning of printed circuit board.
- 5. Check solder joints and position of the component by visual inspection.

Note: When soldering a receptacle, no plug should be mated to the receptacle before completion of this procedure.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 to 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec

*Typical data for reflow process. Alternatively, wave soldering is also possible

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